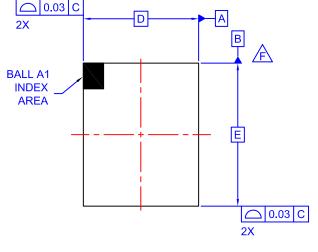


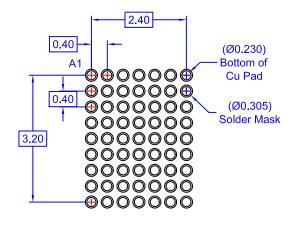
WLCSP63 3.63x2.83x0.522 CASE 567TM ISSUE O

// 0.06 C 0.488±0.038 **DATE 31 MAR 2017**

0.292±0.018

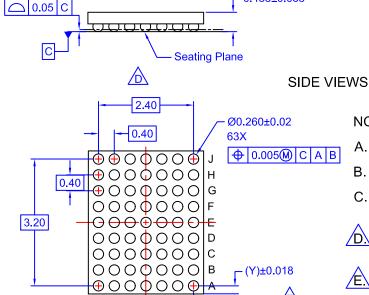
0.196±0.020





TOP VIEW

RECOMMENDED LAND PATTERN (NSMD TYPE)



' **1**

NOTES

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASMEY14.5M, 2009.
- DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- E. PACKAGE NOMINAL HEIGHT IS 488 ± 38 MICRONS (450-526 MICRONS).
- F. FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.

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DESCRIPTION:	WLCSP63 3.63x2.83x0.522		PAGE 1 OF 1

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2 3

4 5 6

BOTTOM VIEW

 $(X)\pm0.018$